



Description

The 9 couples, 3.6/3.0 mm × 1.6mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 74 °C, designed for superior cooling and heating up to 200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

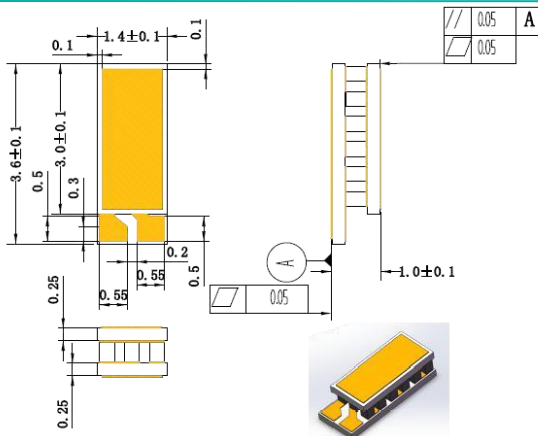
Applications

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Electrical Characteristics

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	74	83	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	1.15	1.24	Voltage applied to the module at DT _{max}
I _{max} (Amps)	1.1	1.1	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	0.83	0.9	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	0.78	0.84	The module resistance is tested under AC
Tolerance (%)	10%		For thermal and electricity parameters

Geometric Characteristics (Dimensions in millimeters)



Manufacturing Options

A. Solder:

T200: CuSn (T_{melt}=227°C)

B. Sealant:

NS: No sealing

C. Ceramics:

Aluminum Nitride (AlN)

D. Ceramics Surface Options:

Hot side: Metalized (Au plating)

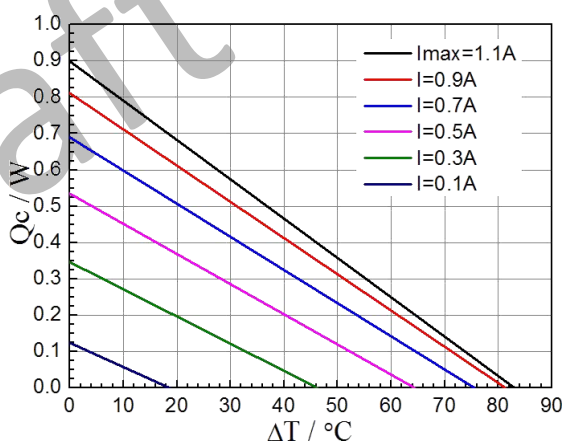
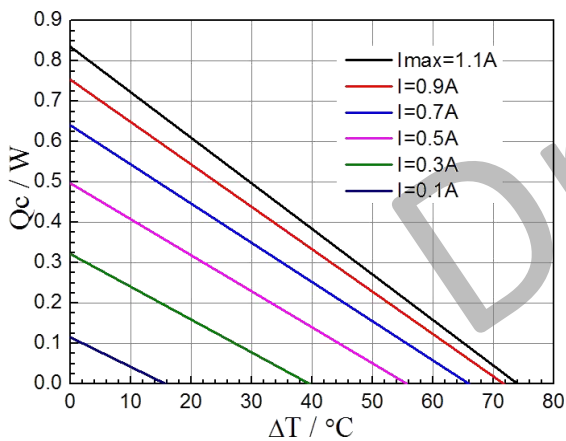
Cold side: Metalized (Au plating)

Ordering Option

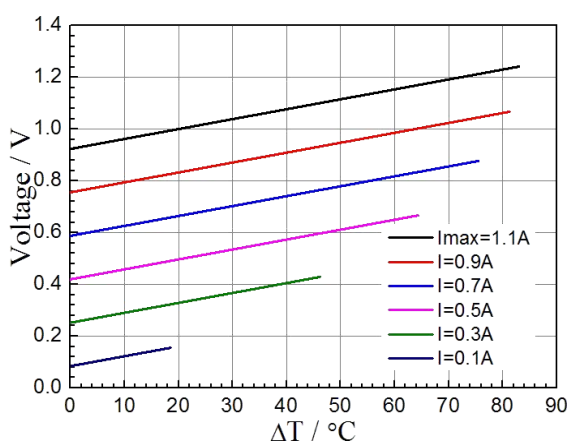
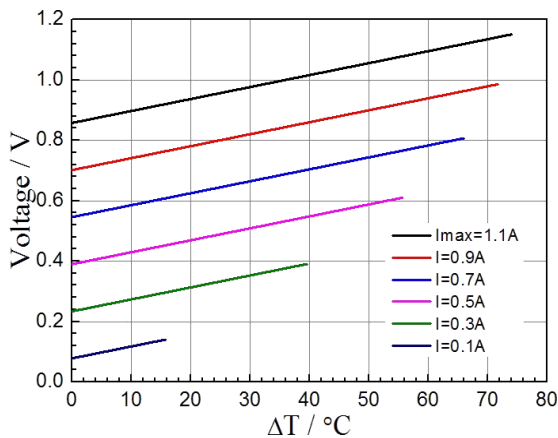
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:1.0± 0.05	0: 0.05/0.05	No Wires

Performance Curves at Th=27 °C

Performance Curves at Th=50 °C

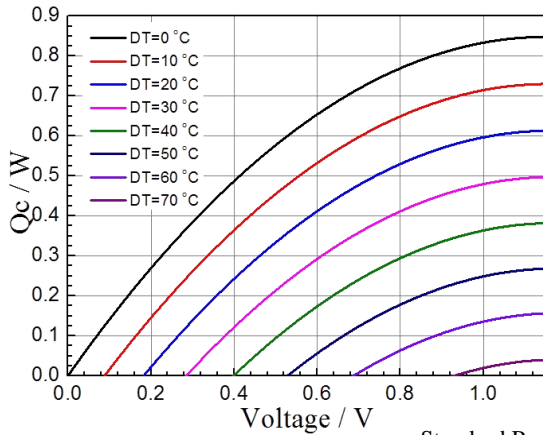


Standard Performance Graph $Q_c = f(DT)$

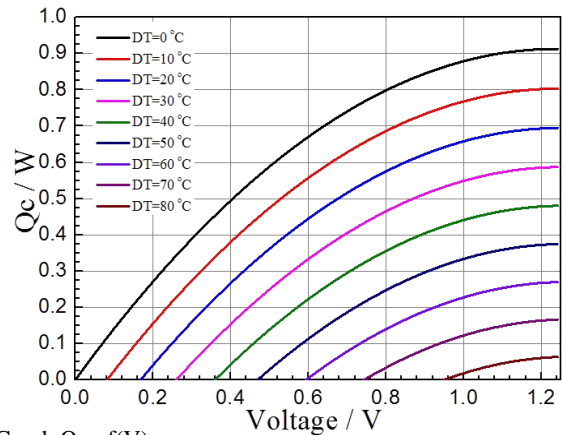


Standard Performance Graph $V = f(DT)$

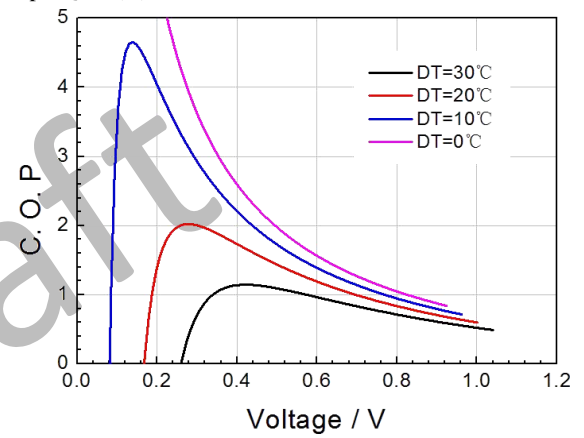
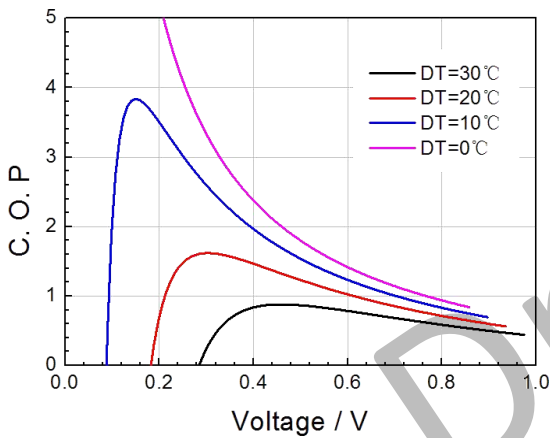
Performance Curves at $T_h=27\text{ }^\circ\text{C}$



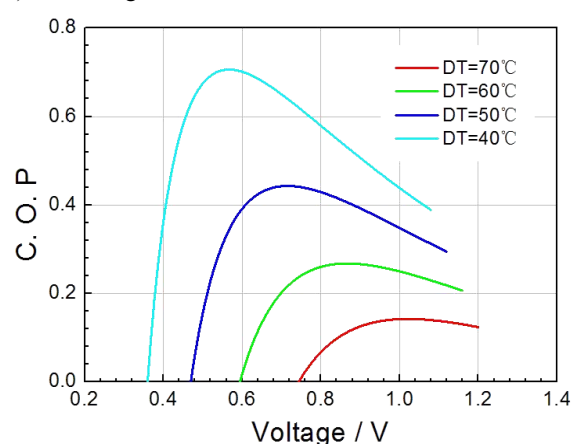
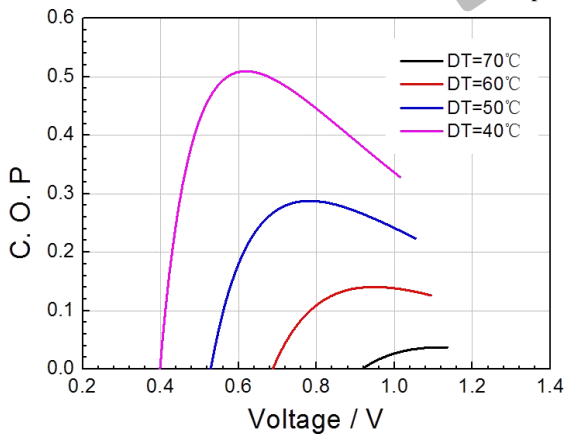
Performance Curves at $T_h=50\text{ }^\circ\text{C}$



Standard Performance Graph $Q_c = f(V)$



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Q_c /Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.